Appl. No.

Filed

October 9, 2001

09/975,466

**REMARKS** 

Claims 1-17, 28 and 30-32 are pending in the present application. Claims 6 and 7 are

allowed. The present amendments are made to clarify that copper oxide is reduced to copper

metal in such a way that copper from the copper oxide is left on the substrate while oxygen from

the copper oxide is removed. Support for the amendments can be found, for example, at page 8,

lines 22-25 and page 9, lines 4-6.

The rejection of Claims 1-5, 8-17, 28 and 30-32 under 35 U.S.C. §103(a) as unpatentable

over the combination of Sundararajan (US 2002/0027286) in view of Donnelly Jr. et al. (US

6,143,658) has been maintained. As discussed in their previous response, Donnelly Jr. et al.

teaches the etching of copper oxide with H(hfac). Thus, Donnelly Jr. et al. does not teach or

suggest reduction of copper oxide on a substrate to leave copper from the copper oxide on the

substrate while removing oxygen from the copper oxide as recited by independent Claims 1 and

28, as amended herein. Dependent Claims 2-5, 8-17 and 30-32 contain all of the features of the

independent claims as well as additional distinguishing features. As a result, Applicants request

withdrawal of the rejection of Claims 1-5, 8-17, 28 and 30-32.

Conclusion

The present application is believed to be in condition for allowance and Applicants

respectfully request the same. If any issues remain, the Examiner is cordially invited to

telephone Applicants' representative at the number provided below in order to resolve such

issues promptly.

Respectfully submitted,

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Dated: October 6, 2004

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